BGA2866

MMIC wideband amplifier

Rev. 4 — 13 July 2015

Product data sheet

1. Product profile

1.1 General description

Silicon Monolithic Microwave Integrated Circuit (MMIC) wideband amplifier with internal matching circuit in a 6-pin SOT363 plastic SMD package.

1.2 Features and benefits

- Input internally matched to 50 Ω
- A gain of 23.2 dB at 250 MHz increasing to 24.3 dB at 2150 MHz
- Output power at 1 dB gain compression = 4 dBm
- Supply current = 17.4 mA at a supply voltage of 5 V
- Reverse isolation > 32 dB up to 2150 MHz
- Good linearity with low second order and third order products
- Noise figure = 3.8 dB at 950 MHz
- Unconditionally stable (K > 1)
- No output inductor required

1.3 Applications

- LNB IF amplifiers
- General purpose low noise wideband amplifier for frequencies between DC and 2.2 GHz

2. Pinning information

Table 1. Pinning

Pin	Description	Simplified outline	Graphic symbol
1	V _{CC}	D- D- D.	,
2, 5	GND2	6 5 4	\sim
3	RF_OUT		63
4	GND1		4 2,5
6	RF_IN	<u> </u> 1	<i>h</i> h
			sym052



MMIC wideband amplifier

3. Ordering information

Table 2. Ordering information

Type number	Package	ackage						
	Name	Description	Version					
BGA2866	-	plastic surface-mounted package; 6 leads	SOT363					

4. Marking

Table 3. Marking

Type number	Marking code	Description		
BGA2866	*ED			
		* = p : made in Hong Kong		
		* = W : made in China		
		* = t : made in Malaysia		

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage	RF input AC coupled	-0.5	+7.0	V
Icc	supply current		-	36	mA
P _{tot}	total power dissipation	T _{sp} = 90 °C	-	200	mW
T _{stg}	storage temperature		-40	+125	°C
Tj	junction temperature		-	125	°C
P _{drive}	drive power		-	+10	dBm

6. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
$R_{th(j-sp)}$	thermal resistance from junction to solder point	$P_{tot} = 200 \text{ mW}; T_{sp} = 90 ^{\circ}\text{C}$	300	K/W

7. Characteristics

Table 6. Characteristics

 $V_{CC} = 5.0 \text{ V}; Z_S = Z_L = 50 \Omega; P_i = -40 \text{ dBm}; T_{amb} = 25 \text{ °C}; measured on demo board; unless otherwise specified.}$

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		4.5	5.0	5.5	V
I _{CC}	supply current		14.7	17.4	20.1	mA

BGA2866

MMIC wideband amplifier

 Table 6.
 Characteristics ...continued

 $V_{CC} = 5.0 \text{ V; } Z_S = Z_L = 50 \Omega; P_i = -40 \text{ dBm; } T_{amb} = 25 \text{ °C; measured on demo board; unless otherwise specified.}$

f = 950 MHz 5 7 8 dBm f = 2150 MHz 2 4 5 dBm	Symbol	Parameter	Conditions	Min	Тур	Max	Unit
RL	Gp	power gain	f = 250 MHz	22.6	23.2	23.8	dB
RL Input return loss			f = 950 MHz	23.2	23.9	24.6	dB
F 950 MHz			f = 2150 MHz	22.8	24.3	25.8	dB
RL_out F = 2150 MHz	RLin	input return loss	f = 250 MHz	18	20	22	dB
RLout Dutput return loss F = 250 MHz			f = 950 MHz	24	26	28	dB
F 950 MHz			f = 2150 MHz	11	18	24	dB
F = 2150 MHz	RL _{out}	output return loss	f = 250 MHz	21	26	30	dB
SSL solation			f = 950 MHz	12	13	14	dB
F = 950 MHz			f = 2150 MHz	10	11	14	dB
F = 2150 MHz S S S S S S S S S	ISL	isolation	f = 250 MHz	40	60	81	dB
NF			f = 950 MHz	41	43	44	dB
F = 950 MHz			f = 2150 MHz	32	35	37	dB
F = 2150 MHz 3.5 3.9 4.3 dB	NF	noise figure	f = 250 MHz	3.4	3.9	4.4	dB
B-3dB −3 dB bandwidth 3 dB below gain at 1 GHz 3.1 3.3 3.4 GHz K Rollett stability factor f = 250 MHz 33 35 37 f = 950 MHz 3.8 4.1 4.4 4.4 PL(sat) saturated output power f = 250 MHz 5 6 7 dBm F = 950 MHz 5 7 8 dBm f = 950 MHz 3 4 5 dBm Moutput power at 1 dB gain compression f = 250 MHz 3 4 5 dBm F = 250 MHz 3 4 5 dBm f = 950 MHz 3 4 5 dBm f = 250 MHz 3 4 5 dBm f = 950 MHz 3 4 5 dBm f = 250 MHz 3 4 5 dBm f = 250 MHz 6 7 4 dBm f = 250 MHz 6 7 4 dBm f = 250 MHz 6 7 4 2 4 7 4 4			f = 950 MHz	3.4	3.8	4.2	dB
Rollett stability factor			f = 2150 MHz	3.5	3.9	4.3	dB
$ \begin{array}{c} f = 950 \text{ MHz} \\ f = 2150 \text{ MHz} \\ f = 2150 \text{ MHz} \\ f = 2150 \text{ MHz} \\ f = 250 \text{ MHz} \\ f = 950 \text{ MHz} \\ f = 950 \text{ MHz} \\ f = 950 \text{ MHz} \\ f = 2150 \text$	B _{-3dB}	-3 dB bandwidth	3 dB below gain at 1 GHz	3.1	3.3	3.4	GHz
$ \begin{array}{c} F_{L(sat)} \\ P_{L(sat)} \\ P_{L(sat)} \\ P_{L(sat)} \\ P_{L(1dB)} \\ P_{L(2d)} \\ P_{L$	K	Rollett stability factor	f = 250 MHz	33	35	37	
$\begin{array}{c} P_{L(sat)} \\ P_{L(sat)} \\ P_{L(sat)} \\ P_{L(sat)} \\ P_{L(1dB)} $			f = 950 MHz	3.8	4.1	4.4	
$ \begin{array}{c} $			f = 2150 MHz	1.3	1.6	1.9	
$\begin{array}{c} F_{L(1dB)} \\ P_{L(1dB)} \\ P_{L(2H)} \\ P_{$	P _{L(sat)}	saturated output power	f = 250 MHz	5	6	7	dBm
$\begin{array}{c} P_{L(1dB)} \\ P_{L(1d)} \\ P_{L(1$			f = 950 MHz	5	7	8	dBm
$ \begin{array}{c} f = 950 \text{ MHz} \\ f = 2150 \text{ MHz} \\ f = 2150 \text{ MHz} \\ \end{array} \begin{array}{c} 3 & 4 & 5 & \text{dBm} \\ \text{dBm} \\ \end{array} \end{array} $ input third-order intercept point $ \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline f_1 = 250 \text{ MHz; } f_2 = 251 \text{ MHz} \\ \hline f_1 = 950 \text{ MHz; } f_2 = 951 \text{ MHz} \\ \hline f_1 = 2150 \text{ MHz; } f_2 = 2151 \text{ MHz} \\ \hline f_1 = 2150 \text{ MHz; } f_2 = 2151 \text{ MHz} \\ \hline \end{array} \begin{array}{c} -6 & -4 & -2 & \text{dBm} \\ \hline -6 & -4 & -2 & \text{dBm} \\ \hline \end{array} \\ \end{array} $ $ \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} P_{drive} = -36 dBm (for$			f = 2150 MHz	2	4	5	dBm
$ \begin{array}{c} \text{IP3}_{\text{I}} \\ \text{IP3}_{\text{I}} \\ \text{Input third-order intercept point} \\ \end{array} \begin{array}{c} P_{\text{drive}} = -36 \text{ dBm (for each tone)} \\ \hline f_1 = 250 \text{ MHz; } f_2 = 251 \text{ MHz} \\ \hline f_1 = 950 \text{ MHz; } f_2 = 951 \text{ MHz} \\ \hline f_1 = 2150 \text{ MHz; } f_2 = 951 \text{ MHz} \\ \hline f_1 = 2150 \text{ MHz; } f_2 = 2151 \text{ MHz} \\ \hline f_1 = 2150 \text{ MHz; } f_2 = 2151 \text{ MHz} \\ \hline \end{array} \begin{array}{c} -6 \\ -4 \\ -2 \\ \text{dBm} \\ \hline \end{array} \begin{array}{c} -2 \\ \text{dBm} \\ \hline \end{array} \\ \end{array} $ $ \begin{array}{c} \text{IP3}_{\text{O}} \\ \text{IP3}_{\text{O}} \\ \end{array} \begin{array}{c} \text{Output third-order intercept point} \\ \hline \\ P_{\text{drive}} = -36 \text{ dBm (for each tone)} \\ \hline \\ f_1 = 250 \text{ MHz; } f_2 = 251 \text{ MHz} \\ \hline \\ f_1 = 950 \text{ MHz; } f_2 = 251 \text{ MHz} \\ \hline \end{array} \begin{array}{c} 17 \\ 19 \\ 21 \\ \text{dBm} \\ \hline \\ f_1 = 2150 \text{ MHz; } f_2 = 2151 \text{ MHz} \\ \hline \end{array} \begin{array}{c} 15 \\ 17 \\ 20 \\ \text{dBm} \\ \hline \end{array} \\ \begin{array}{c} P_{\text{L(2H)}} \\ \hline \end{array} \begin{array}{c} \text{Second harmonic output power} \\ \hline \\ P_{\text{drive}} = -33 \text{ dBm} \\ \hline \\ f_{1H} = 250 \text{ MHz; } f_{2H} = 500 \text{ MHz} \\ \hline \\ f_{2H} = 950 \text{ MHz; } f_{2H} = 1900 \text{ MHz} \\ \hline \end{array} \begin{array}{c} -53 \\ -51 \\ -49 \\ \text{dBm} \\ \hline \end{array} \\ \begin{array}{c} A\text{IM2} \\ \hline \end{array} \begin{array}{c} \text{Second-order intermodulation distance} \\ \hline \end{array} \begin{array}{c} P_{\text{drive}} = -36 \text{ dBm (for each tone)} \\ \hline \end{array} \begin{array}{c} 1 \\ 5 \\ 6 \\ 6 \\ 7 \\ 7 \\ 8 \end{array} \begin{array}{c} 36 \\ 6 \\ 7 \\ 7 \\ 8 \end{array} \begin{array}{c} 4 \\ 6 \\ 6 \\ 8 \\ 6 \\ 8 \end{array} \end{array}$	P _{L(1dB)}	output power at 1 dB gain compression	f = 250 MHz	3	4	5	dBm
$ \begin{array}{c} \text{IP3}_{\text{l}} \\ \text{IP3}_{\text{l}} \\ \text{Input third-order intercept point} \\ \end{array} \begin{array}{c} P_{\text{drive}} = -36 \text{ dBm (for each tone)} \\ \hline f_{1} = 250 \text{ MHz; } f_{2} = 251 \text{ MHz} \\ \hline f_{1} = 950 \text{ MHz; } f_{2} = 951 \text{ MHz} \\ \hline f_{1} = 2150 \text{ MHz; } f_{2} = 951 \text{ MHz} \\ \hline f_{1} = 2150 \text{ MHz; } f_{2} = 2151 \text{ MHz} \\ \hline \end{array} \begin{array}{c} -9 \\ -7 \\ -4 \\ \text{dBm} \\ \hline \end{array} \\ \end{array} $			f = 950 MHz	3	4	5	dBm
$ \begin{array}{c} f_1 = 250 \text{ MHz}; \ f_2 = 251 \text{ MHz} & -6 & -4 & -2 & \text{dBm} \\ f_1 = 950 \text{ MHz}; \ f_2 = 951 \text{ MHz} & -9 & -7 & -4 & \text{dBm} \\ f_1 = 2150 \text{ MHz}; \ f_2 = 2151 \text{ MHz} & -16 & -12 & -9 & \text{dBm} \\ \hline \\ IP3_O \\ & & & & & & & & & & & & & & & & & \\ & & & & & & & & & & & & & \\ IP3_O \\ & & & & & & & & & & & & & \\ & & & & $			f = 2150 MHz	1	3	4	dBm
$ \begin{array}{c} f_1 = 950 \text{ MHz}; \ f_2 = 951 \text{ MHz} & -9 & -7 & -4 & \text{dBm} \\ f_1 = 2150 \text{ MHz}; \ f_2 = 2151 \text{ MHz} & -16 & -12 & -9 & \text{dBm} \\ \end{array} \\ IP3_O \\ IP3_$	IP3 _I	input third-order intercept point	P _{drive} = -36 dBm (for each tone)				
$ \begin{array}{c} & f_1 = 2150 \text{ MHz}; \ f_2 = 2151 \text{ MHz} & -16 & -12 & -9 & \text{dBm} \\ & f_1 = 2150 \text{ MHz}; \ f_2 = 2151 \text{ MHz} & -16 & -12 & -9 & \text{dBm} \\ & P_{drive} = -36 \text{ dBm (for each tone)} & & & & & \\ & f_1 = 250 \text{ MHz}; \ f_2 = 251 \text{ MHz} & 17 & 19 & 21 & \text{dBm} \\ & f_1 = 950 \text{ MHz}; \ f_2 = 951 \text{ MHz} & 15 & 17 & 20 & \text{dBm} \\ & f_1 = 2150 \text{ MHz}; \ f_2 = 2151 \text{ MHz} & 9 & 12 & 15 & \text{dBm} \\ & & & & & & & & & \\ & P_{drive} = -33 \text{ dBm} & & & & & \\ & & & & & & & & \\ & & & & $			f ₁ = 250 MHz; f ₂ = 251 MHz	-6	-4	-2	dBm
$ P_{drive} = -36 \text{ dBm (for each tone)} $			f ₁ = 950 MHz; f ₂ = 951 MHz	-9	-7	-4	dBm
			f ₁ = 2150 MHz; f ₂ = 2151 MHz	-16	-12	-9	dBm
$ \begin{array}{c} f_1 = 950 \; \text{MHz}; \; f_2 = 951 \; \text{MHz} \\ f_1 = 2150 \; \text{MHz}; \; f_2 = 2151 \; \text{MHz} \\ \end{array} \begin{array}{c} 9 \\ 9 \\ 12 \\ 15 \\ \text{dBm} \\ \end{array} \\ P_{\text{L(2H)}} \\ P_{\text{L(2H)}} \\ P_{\text{C(2H)}} \\ P_{$	IP3 _O	output third-order intercept point	P _{drive} = -36 dBm (for each tone)				
$f_{1} = 2150 \text{ MHz}; \ f_{2} = 2151 \text{ MHz} \qquad 9 \qquad 12 \qquad 15 \qquad \text{dBm}$ $P_{\text{L(2H)}} \qquad \text{second harmonic output power} \qquad P_{\text{drive}} = -33 \text{ dBm} \qquad \qquad$			f ₁ = 250 MHz; f ₂ = 251 MHz	17	19	21	dBm
$ \begin{array}{c} {\sf P}_{\sf L(2H)} \\ {\sf P}_{\sf L(2H)} \\ {\sf E}_{\sf L(2H)} \\ {\sf E$			f ₁ = 950 MHz; f ₂ = 951 MHz	15	17	20	dBm
$f_{1H} = 250 \text{ MHz}; f_{2H} = 500 \text{ MHz} \qquad -53 \qquad -51 \qquad -49 \qquad \text{dBm}$ $f_{1H} = 950 \text{ MHz}; f_{2H} = 1900 \text{ MHz} \qquad -43 \qquad -41 \qquad -40 \qquad \text{dBm}$ $\Delta \text{IM2} \qquad \text{second-order intermodulation distance} \qquad P_{\text{drive}} = -36 \text{ dBm (for each tone)} \qquad \qquad$			f ₁ = 2150 MHz; f ₂ = 2151 MHz	9	12	15	dBm
$f_{1H} = 250 \text{ MHz}; \ f_{2H} = 500 \text{ MHz} \qquad -53 \qquad -51 \qquad -49 \qquad \text{dBm}$ $f_{1H} = 950 \text{ MHz}; \ f_{2H} = 1900 \text{ MHz} \qquad -43 \qquad -41 \qquad -40 \qquad \text{dBm}$ $\Delta \text{IM2} \qquad \text{second-order intermodulation distance} \qquad P_{\text{drive}} = -36 \text{ dBm (for each tone)} \qquad \qquad$	P _{L(2H)}	second harmonic output power	P _{drive} = -33 dBm				
Δ IM2 second-order intermodulation distance $ P_{drive} = -36 \text{ dBm (for each tone)} $ $ f_1 = 250 \text{ MHz; } f_2 = 251 \text{ MHz} $ $ 36 47 58 \text{dBc} $			f _{1H} = 250 MHz; f _{2H} = 500 MHz	-53	-51	-49	dBm
$f_1 = 250 \text{ MHz}; f_2 = 251 \text{ MHz}$ 36 47 58 dBc			f _{1H} = 950 MHz; f _{2H} = 1900 MHz	-43	-41	-40	dBm
	ΔΙΜ2	second-order intermodulation distance	P _{drive} = -36 dBm (for each tone)				
$f_1 = 950 \text{ MHz}; f_2 = 951 \text{ MHz}$ 32 43 55 dBc			f ₁ = 250 MHz; f ₂ = 251 MHz	36	47	58	dBc
			f ₁ = 950 MHz; f ₂ = 951 MHz	32	43	55	dBc

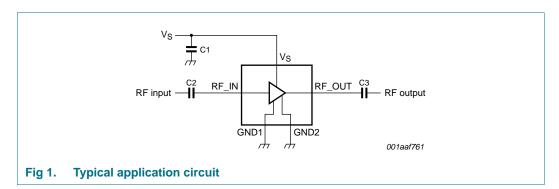
MMIC wideband amplifier

8. Application information

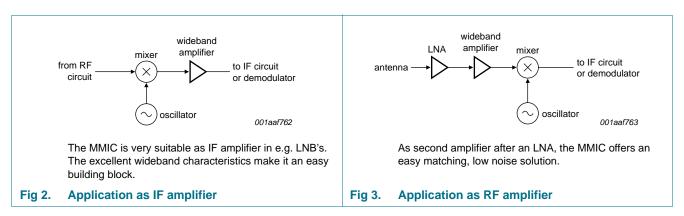
<u>Figure 1</u> shows a typical application circuit for the BGA2866 MMIC. The device is internally matched to $50~\Omega$ and therefore does not need any external matching. The value of the input and output DC blocking capacitors C2 and C3 should not be more than 100 pF for applications above 100 MHz. However, when the device is operated below 100 MHz, the capacitor value should be increased.

The 22 nF supply decoupling capacitor C1 should be located as close as possible to the MMIC.

The PCB top ground plane, connected to pins 2, 4 and 5 must be as close as possible to the MMIC, preferably also below the MMIC. When using via holes, use multiple via holes as close as possible to the MMIC.



8.1 Application examples



MMIC wideband amplifier

8.2 Graphs

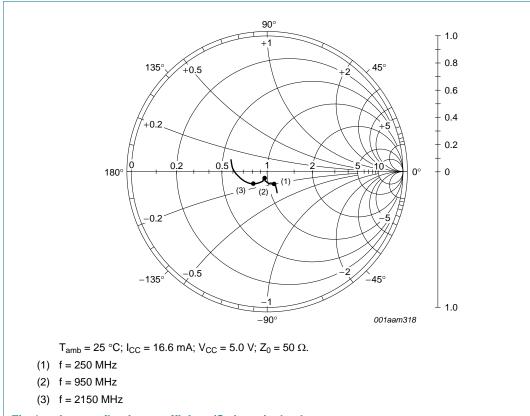
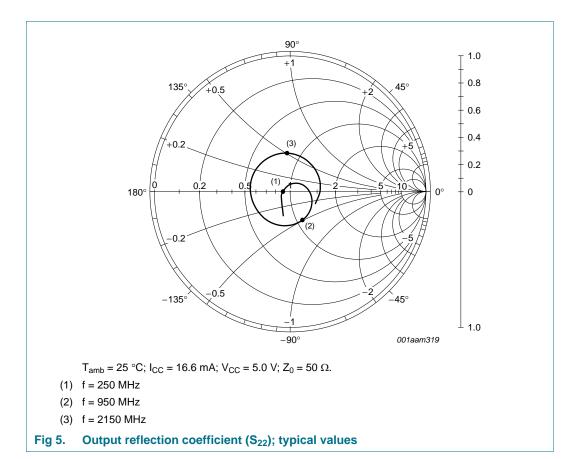
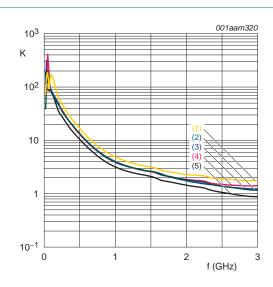


Fig 4. Input reflection coefficient (S₁₁); typical values



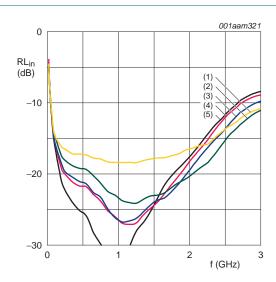
MMIC wideband amplifier



 $P_{drive} = -40 \text{ dBm}$; $Z_0 = 50 \Omega$.

- (1) $V_{CC} = 4.5 \text{ V}$; $T_{amb} = 85 \,^{\circ}\text{C}$; $I_{CC} = 14.36 \,\text{mA}$
- (2) $V_{CC} = 4.5 \text{ V}$; $T_{amb} = -40 \,^{\circ}\text{C}$; $I_{CC} = 16.41 \,\text{mA}$
- (3) $V_{CC} = 5.0 \text{ V}$; $T_{amb} = 25 \,^{\circ}\text{C}$; $I_{CC} = 16.63 \,\text{mA}$
- (4) $V_{CC} = 5.5 \text{ V}$; $T_{amb} = 85 \,^{\circ}\text{C}$; $I_{CC} = 17.27 \,\text{mA}$
- (5) $V_{CC} = 5.5 \text{ V}$; $T_{amb} = -40 \,^{\circ}\text{C}$; $I_{CC} = 19.29 \,\text{mA}$

Fig 6. Rollett stability factor as function of frequency; typical values

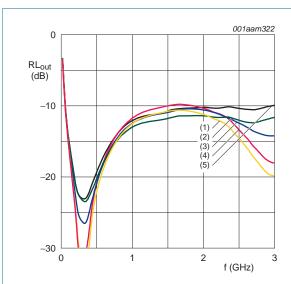


 $P_{drive} = -40 \text{ dBm}$; $Z_0 = 50 \Omega$.

- (1) $V_{CC} = 4.5 \text{ V}$; $T_{amb} = 85 \,^{\circ}\text{C}$; $I_{CC} = 14.36 \,\text{mA}$
- (2) $V_{CC} = 4.5 \text{ V}$; $T_{amb} = -40 \,^{\circ}\text{C}$; $I_{CC} = 16.41 \,\text{mA}$
- (3) $V_{CC} = 5.0 \text{ V}$; $T_{amb} = 25 \,^{\circ}\text{C}$; $I_{CC} = 16.63 \,\text{mA}$
- (4) $V_{CC} = 5.5 \text{ V}$; $T_{amb} = 85 \,^{\circ}\text{C}$; $I_{CC} = 17.27 \,\text{mA}$
- (5) $V_{CC} = 5.5 \text{ V}$; $T_{amb} = -40 \,^{\circ}\text{C}$; $I_{CC} = 19.29 \,\text{mA}$

Fig 7. Input return loss as function of frequency; typical values

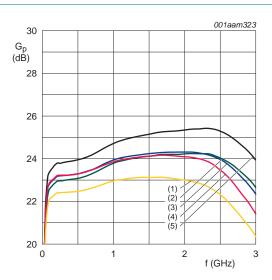
MMIC wideband amplifier



 $P_{drive} = -40 \text{ dBm}$; $Z_0 = 50 \Omega$.

- (1) $V_{CC} = 4.5 \text{ V}$; $T_{amb} = 85 \,^{\circ}\text{C}$; $I_{CC} = 14.36 \,\text{mA}$
- (2) $V_{CC} = 4.5 \text{ V}$; $T_{amb} = -40 \,^{\circ}\text{C}$; $I_{CC} = 16.41 \,\text{mA}$
- (3) $V_{CC} = 5.0 \text{ V}$; $T_{amb} = 25 \,^{\circ}\text{C}$; $I_{CC} = 16.63 \,\text{mA}$
- (4) $V_{CC} = 5.5 \text{ V}$; $T_{amb} = 85 \,^{\circ}\text{C}$; $I_{CC} = 17.27 \,\text{mA}$
- (5) $V_{CC} = 5.5 \text{ V}$; $T_{amb} = -40 \,^{\circ}\text{C}$; $I_{CC} = 19.29 \,\text{mA}$

Fig 8. Output return loss as function of frequency; typical values

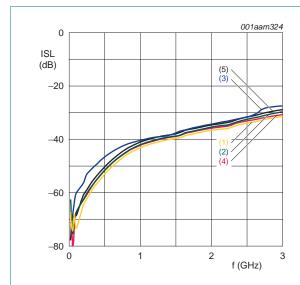


 $P_{drive} = -40 \text{ dBm}; Z_0 = 50 \Omega.$

- (1) $V_{CC} = 4.5 \text{ V}$; $T_{amb} = 85 \,^{\circ}\text{C}$; $I_{CC} = 14.36 \,\text{mA}$
- (2) $V_{CC} = 4.5 \text{ V}$; $T_{amb} = -40 \,^{\circ}\text{C}$; $I_{CC} = 16.41 \,\text{mA}$
- (3) $V_{CC} = 5.0 \text{ V}$; $T_{amb} = 25 \,^{\circ}\text{C}$; $I_{CC} = 16.63 \,\text{mA}$
- (4) $V_{CC} = 5.5 \text{ V}$; $T_{amb} = 85 \,^{\circ}\text{C}$; $I_{CC} = 17.27 \,\text{mA}$
- (5) $V_{CC} = 5.5 \text{ V}$; $T_{amb} = -40 \,^{\circ}\text{C}$; $I_{CC} = 19.29 \,\text{mA}$

Fig 9. Power gain as function of frequency; typical values

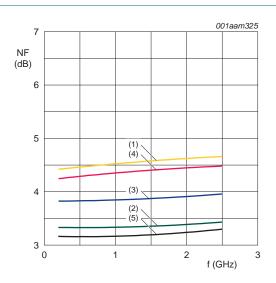
MMIC wideband amplifier



 $P_{drive} = -40 \text{ dBm}$; $Z_0 = 50 \Omega$.

- (1) $V_{CC} = 4.5 \text{ V}$; $T_{amb} = 85 \,^{\circ}\text{C}$; $I_{CC} = 14.36 \,\text{mA}$
- (2) $V_{CC} = 4.5 \text{ V}$; $T_{amb} = -40 \,^{\circ}\text{C}$; $I_{CC} = 16.41 \,\text{mA}$
- (3) $V_{CC} = 5.0 \text{ V}$; $T_{amb} = 25 \,^{\circ}\text{C}$; $I_{CC} = 16.63 \,\text{mA}$
- (4) $V_{CC} = 5.5 \text{ V}$; $T_{amb} = 85 \,^{\circ}\text{C}$; $I_{CC} = 17.27 \,\text{mA}$
- (5) $V_{CC} = 5.5 \text{ V}$; $T_{amb} = -40 \,^{\circ}\text{C}$; $I_{CC} = 19.29 \,\text{mA}$

Fig 10. Isolation as function of frequency; typical values



 $Z_0 = 50 \Omega$.

- (1) $V_{CC} = 4.5 \text{ V}$; $T_{amb} = 85 \,^{\circ}\text{C}$; $I_{CC} = 14.36 \,\text{mA}$
- (2) $V_{CC} = 4.5 \text{ V}$; $T_{amb} = -40 \,^{\circ}\text{C}$; $I_{CC} = 16.41 \,\text{mA}$
- (3) $V_{CC} = 5.0 \text{ V}$; $T_{amb} = 25 \,^{\circ}\text{C}$; $I_{CC} = 16.63 \,\text{mA}$
- (4) $V_{CC} = 5.5 \text{ V}$; $T_{amb} = 85 \,^{\circ}\text{C}$; $I_{CC} = 17.27 \,\text{mA}$
- (5) $V_{CC} = 5.5 \text{ V}$; $T_{amb} = -40 \,^{\circ}\text{C}$; $I_{CC} = 19.29 \,\text{mA}$

Fig 11. Noise figure as function of frequency; typical values

8.3 Tables

Table 7. Supply current over temperature and supply voltages Typical values.

Symbol	Parameter	Conditions	T _{amb} (°C)			Unit
			-40	+25	+85	
I _{CC}	supply current	V _{CC} = 4.5 V	16.41	15.27	14.36	mA
		$V_{CC} = 5.0 \text{ V}$	17.73	16.63	15.85	mA
		$V_{CC} = 5.5 \text{ V}$	19.29	17.73	17.27	mA

Table 8. Second harmonic output power over temperature and supply voltages Typical values.

Symbol	Parameter	Conditions	T _{amb} (°C)		Unit	
			-40	+25	+85	
P _{L(2H)}	second harmonic output power	$f = 250 \text{ MHz}; P_{drive} = -33 \text{ dBm}$				
		V _{CC} = 4.5 V	-48	-49	-51	dBm
		V _{CC} = 5.0 V	-49	-51	-53	dBm
		V _{CC} = 5.5 V	-50	-52	-54	dBm
		$f = 950 \text{ MHz}; P_{drive} = -33 \text{ dBm}$				
		V _{CC} = 4.5 V	-40	-41	-42	dBm
		V _{CC} = 5.0 V	-40	-41	-42	dBm
		V _{CC} = 5.5 V	-40	-41	-42	dBm

BGA2866

All information provided in this document is subject to legal disclaimers.

© NXP Semiconductors N.V. 2015. All rights reserved.

Table 9. Input power at 1 dB gain compression over temperature and supply voltages *Typical values*.

Symbol	Parameter	Conditions	T _{amb} (°C)			Unit
			-40	+25	+85	
P _{i(1dB)}	input power at 1 dB gain compression	f = 250 MHz				
		V _{CC} = 4.5 V	-18	-18	-19	dBm
		V _{CC} = 5.0 V	-18	-18	-18	dBm
		V _{CC} = 5.5 V	-17	-18	-18	dBm
		f = 950 MHz				
		V _{CC} = 4.5 V	-19	-19	-19	dBm
		V _{CC} = 5.0 V	-18	-18	-19	dBm
		$V_{CC} = 5.5 \text{ V}$	-18	-18	-18	dBm
		f = 2150 MHz				
		$V_{CC} = 4.5 \text{ V}$	-20	-21	-22	dBm
		V _{CC} = 5.0 V	-20	-21	-22	dBm
		V _{CC} = 5.5 V	-20	-21	-22	dBm

Table 10. Output power at 1 dB gain compression over temperature and supply voltages *Typical values*.

Symbol	Parameter	Conditions	T _{amb} (°C)		Unit	
			-40	+25	+85	
P _{L(1dB)}	output power at 1 dB gain compression	f = 250 MHz				
		V _{CC} = 4.5 V	4	3	3	dBm
		V _{CC} = 5.0 V	5	4	4	dBm
		V _{CC} = 5.5 V	5	5	4	dBm
		f = 950 MHz				
		V _{CC} = 4.5 V	4	3	3	dBm
		V _{CC} = 5.0 V	5	4	4	dBm
		V _{CC} = 5.5 V	6	5	4	dBm
		f = 2150 MHz				
		V _{CC} = 4.5 V	3	2	0	dBm
		V _{CC} = 5.0 V	4	2	1	dBm
		V _{CC} = 5.5 V	4	3	1	dBm

Table 11. Saturated output power over temperature and supply voltages *Typical values*.

Symbol	Parameter	Conditions	T _{amb}	(°C)		Unit
			-40	+25	+85	
P _{L(sat)}	saturated output power	f = 250 MHz				
		V _{CC} = 4.5 V	6	5	5	dBm
		V _{CC} = 5.0 V	7	6	6	dBm
		V _{CC} = 5.5 V	8	7	6	dBm
		f = 950 MHz				
		V _{CC} = 4.5 V	6	5	5	dBm
		V _{CC} = 5.0 V	7	7	5	dBm
		V _{CC} = 5.5 V	8	7	6	dBm
		f = 2150 MHz				
		V _{CC} = 4.5 V	4	3	2	dBm
		V _{CC} = 5.0 V	5	4	2	dBm
		V _{CC} = 5.5 V	5	4	2	dBm

Table 12. Second-order intermodulation distance over temperature and supply voltages *Typical values*.

Symbol	Parameter	Conditions	Tamb	T _{amb} (°C)		
			-40	+25	+85	
ΔIM2 second-order intermodulation dista	second-order intermodulation distance	f ₁ = 250 MHz; f ₂ = 251 MHz; P _{drive} = -36 dBm				
		V _{CC} = 4.5 V	40	42	46	dBc
		V _{CC} = 5.0 V	44	47	51	dBc
		V _{CC} = 5.5 V	48	51	56	dBc
		f ₁ = 950 MHz; f ₂ = 951 MHz; P _{drive} = -36 dBm				
		V _{CC} = 4.5 V	38	40	43	dBc
		V _{CC} = 5.0 V	42	43	45	dBc
		V _{CC} = 5.5 V	45	46	46	dBc

Table 13. Output third-order intercept point over temperature and supply voltages *Typical values*.

Symbol	Parameter	Conditions	T _{amb}	T _{amb} (°C)		
			-40	+25	+85	
IP3 _O	output third-order intercept point	$f_1 = 250 \text{ MHz};$ $f_2 = 251 \text{ MHz};$ $P_{drive} = -36 \text{ dBm}$				
		V _{CC} = 4.5 V	18	18	17	dBm
		V _{CC} = 5.0 V	20	19	18	dBm
		V _{CC} = 5.5 V	21	19	19	dBm
		$f_1 = 950 \text{ MHz};$ $f_2 = 951 \text{ MHz};$ $P_{drive} = -36 \text{ dBm}$				
		V _{CC} = 4.5 V	17	16	15	dBm
		V _{CC} = 5.0 V	18	17	16	dBm
		V _{CC} = 5.5 V	20	18	16	dBm
		$f_1 = 2150 \text{ MHz};$ $f_2 = 2151 \text{ MHz};$ $P_{drive} = -36 \text{ dBm}$				
		V _{CC} = 4.5 V	13	11	9	dBm
		V _{CC} = 5.0 V	14	12	9	dBm
		V _{CC} = 5.5 V	15	12	10	dBm

Table 14. -3 dB bandwidth over temperature and supply voltages *Typical values*.

Symbol	Parameter	Conditions	T _{amb} (°C)		Unit	
			-40	+25	+85	
B _{-3dB}	–3 dB bandwidth	V _{CC} = 4.5 V	3.375	3.245	3.059	GHz
		V _{CC} = 5.0 V	3.399	3.265	3.069	GHz
		V _{CC} = 5.5 V	3.416	3.278	3.078	GHz

MMIC wideband amplifier

9. Test information

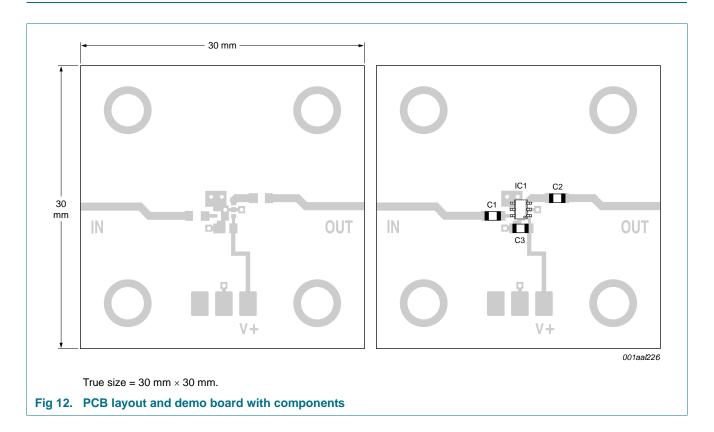


Table 15. List of components used for the typical application

Component	Description	Value	Dimensions
C1, C2	multilayer ceramic chip capacitor	100 pF	0603
C3	multilayer ceramic chip capacitor	22 nF	0603
IC1	BGA2866 MMIC	-	SOT363

MMIC wideband amplifier

10. Package outline

Plastic surface-mounted package; 6 leads

SOT363

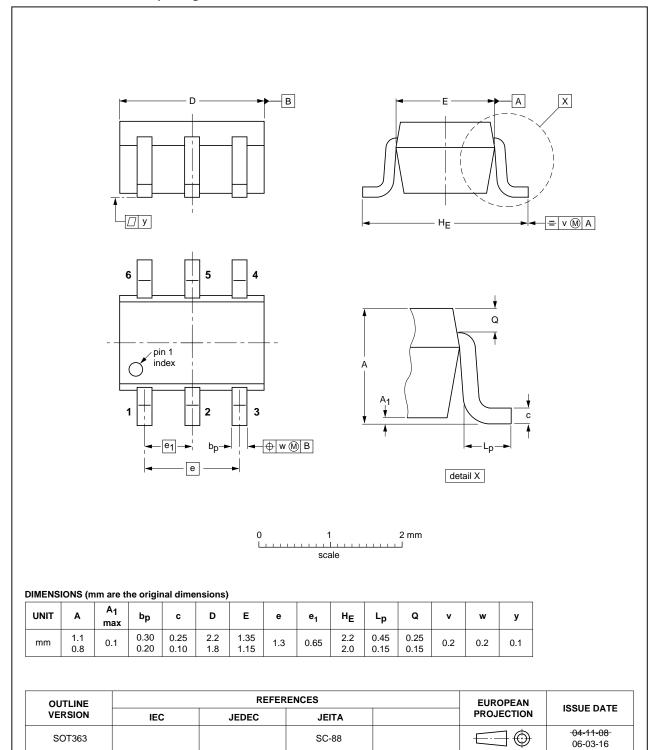


Fig 13. Package outline SOT363

BGA2866

MMIC wideband amplifier

11. Abbreviations

Table 16. Abbreviations

Acronym	Description
IF	Intermediate Frequency
LNA	Low-Noise Amplifier
LNB	Low-Noise Block converter
PCB	Printed-Circuit Board
SMD	Surface Mounted Device

12. Revision history

Table 17. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
BGA2866 v.4	20150713	Product data sheet	-	BGA2866 v.3	
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropriate. 				
BGA2866 v.3	20130827	Product data sheet	-	BGA2866 v.2	
BGA2866 v.2	20101101	Product data sheet	-	BGA2866 v.1	
BGA2866 v.1	20100817	Product data sheet	-	-	

BGA2866 NXP Semiconductors

MMIC wideband amplifier

13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- The term 'short data sheet' is explained in section "Definitions"
- The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

13.2 **Definitions**

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for guick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

13.3 **Disclaimers**

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the Terms and conditions of commercial sale of NXP Semiconductors

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXF Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

BGA2866

All information provided in this document is subject to legal disclaimers.

© NXP Semiconductors N.V. 2015. All rights reserved.

MMIC wideband amplifier

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond

NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

Translations — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

13.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

14. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

BGA2866 NXP Semiconductors

MMIC wideband amplifier

15. Contents

1	Product profile
1.1	General description 1
1.2	Features and benefits
1.3	Applications
2	Pinning information 1
3	Ordering information 2
4	Marking 2
5	Limiting values 2
6	Thermal characteristics 2
7	Characteristics 2
8	Application information 4
8.1	Application examples 4
8.2	Graphs
8.3	Tables
9	Test information
10	Package outline 14
11	Abbreviations
12	Revision history
13	Legal information 16
13.1	Data sheet status
13.2	Definitions
13.3	Disclaimers
13.4	Trademarks 17
14	Contact information 17
15	Contents 18

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for RF Amplifier category:

Click to view products by NXP manufacturer:

Other Similar products are found below:

A82-1 BGA622H6820XTSA1 BGA 728L7 E6327 BGB719N7ESDE6327XTMA1 HMC397-SX HMC405 HMC561-SX HMC8120-SX HMC8121-SX HMC-ALH382-SX HMC-ALH476-SX SE2433T-R SMA3101-TL-E SMA39 A66-1 A66-3 A67-1 LX5535LQ LX5540LL MAAM02350 HMC3653LP3BETR HMC549MS8GETR HMC-ALH435-SX SMA101 SMA32 SMA411 SMA531 SST12LP17E-XX8E SST12LP19E-QX6E WPM0510A HMC5929LS6TR HMC5879LS7TR HMC1126 HMC1087F10 HMC1086 HMC1016 SMA1212 MAX2689EWS+T MAAMSS0041TR MAAM37000-A1G LTC6430AIUF-15#PBF CHA5115-QDG SMA70-2 SMA4011 A231 HMC-AUH232 LX5511LQ LX5511LQ-TR HMC7441-SX HMC-ALH310